CHEMTRONICS® Technical Data Sheet

TDS # CW2400

CircuitWorks® Conductive Epoxy

PRODUCT DESCRIPTION

CircuitWorks[®] Conductive Epoxy is a two part, silver epoxy used in prototype, repair and general conductive bonding applications. CW2400 features strong mechanical bonds, excellent electrical conductivity, and quick room temperature curing. CircuitWorks[®] Conductive Epoxy bonds aggressively to a wide variety of materials.

- Two-component product
- Simple mixing ratios
- Excellent electrical conductivity
- Fast curing
- High strength bond
- Bonds dissimilar surfaces
- Operating temperature range from
- -91°C (-131°F) to 100°C (212°F)

TYPICAL APPLICATIONS

CircuitWorks[®] Conductive Epoxy may be used for electronics applications including:

- Conductive Bonds Between Heat Sensitive Components
- Solderless Surface Mount Connections
- Circuit Board Trace Repair
- Static Discharge and Grounding
- Solder Repair
- Conductive Structural Adhesions

TYPICAL PRODUCT DATA AND PHYSICAL PROPERTIES

Composition				
Material	Part A	Epoxy		
	Part B	Hardener		
Specific Gravity		2.85		
(Parts A & B Mixed	d)			
Cured Compound				
Volume Resistivity		<0.001 ohm-cm		
Thermal Conductivity				
Cal-cm/sec-cm ² -°C		3.8×10^{-3}		
BTU-in/hr-ft ² -°F		11.0		
W/m°K		1.6		
Operating Tempera	ture	-131 to 212°F		
Range		(-91 to 100°C)		
Lap Shear		>1200 lbs/in ⁻		
(ASTM D-1002)				
Shore Hardness		>70		
Adhesion		Excellent		
Cured Flexibility		Excellent		
Chemical Resistance	ee	Excellent		
Moisture Resistance	e	Good		
Typical Thickness		5 mil		
Shelflife		12 months		
Conditions: Store at temperatures below 120° F				

COMPATIBILITY

CircuitWorks[®] Conductive Epoxy is generally compatible with most materials used in printed circuit board fabrication. As with any adhesive/sealant, compatibility with substrate should be determined on a non-critical area prior to use.

USAGE INSTRUCTIONS Read MSDS carefully prior to use.

Cleaning: For best results, clean the board with one of Chemtronics[®] Electro-Wash[®] or Pow-R-Wash[®] cleaners in order to remove any surface contamination which may prevent adequate material contact.

Mixing: Mix equal amounts (1:1) by weight or volume of Part A and Part B. Mix thoroughly for 2 minutes and apply within 8 minutes.

Thinning: Do not attempt to thin.

Curing: Curing times and electrical conductivity depend primarily temperature. For fastest curing times, maximum conductivity and adhesion, cure the bond between 150-250°F (65-121°C) for 5-10 minutes. CircuitWorks® Conductive Epoxy can be room temperature cured at or above 75°F (25°C), for 4 hours. Maximum conductivity and bond strength are achieved in 24 hours. Curing at temperatures below 75°F (25°C) will result in a loss of conductivity and adhesion.

Pot Life: 8-10 Minutes at 75°F (25°C) after mixing.

AVAILABILITY

CW2400

7g/ 0.25 oz. Adhesive & 7g/ 0.25 oz. Hardener

TECHNICAL & APPLICATION ASSISTANCE

Chemtronics[®] provides a technical hotline to answer your technical and application related questions. The toll free number is: **1-800-TECH-401.**

NOTE:

This information is believed to be accurate. It is intended for professional end users having the skills to evaluate and use the data properly. CHEMTRONICS® does not guarantee the accuracy of the data and assumes no liability in connection with damages incurred while using it.

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